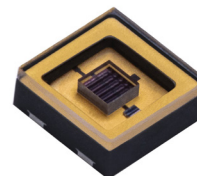


# XBT-3535-UV

## Surface Mount UVC LED



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### Features:

- UVC LED with emission wavelength between 270 nm and 285 nm
- High Optical Power: Up to 80 mW of UVC power at maximum rated current
- Compact form factor: 3.5 mm x 3.5 mm package with optically transparent window
- Viewing angle of 130 degrees
- Standard SMT process
- RoHS and REACH compliant

### Applications

- Water/ Air/ Surface Disinfection
- Healthcare
- Food & Pharmaceutical Processing
- Analytical Instruments
- Horticulture

## XBT-3535-UV Binning Structure

XBT-3535-UV LEDs are tested at a drive current of 350 mA, 20 ms single pulse at 25° C and placed into one of the following radiometric flux, wavelength, and forward voltage bins.

### Radiometric Flux Bins

The LEDs can also be driven at higher drive currents, to achieve the correlated flux values listed in the table.

Flux Bin (FF)	Minimum Flux (mW) 350 mA, 25° C	Maximum Flux (mW) 350 mA, 25° C	Correlated Minimum Flux (mW) at 25° C		
			500 mA	650 mA	800 mA
CC	30	35	42	55	68
CD	35	40	49	64	79
CE	40	45	56	74	90
CF	45	50	63	83	101
CG	50	55	70	92	113

*Note 1: Product lifetime is a function of drive current. Sustained operation at absolute maximum current of 800 mA will result in a reduction of device lifetime compared to typical forward drive currents (350 mA-500 mA). Actual device lifetimes will also depend on junction temperature. Contact Luminus for information on product lifetime.*

### Wavelength Bins

Wavelength Bin (WWW)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
270	270	275
275	275	280
280	280	285

*Note 2: Luminus maintains a +/- 6% tolerance on flux measurements and +/- 1 nm on wavelength measurements.*

### Forward Voltage Bins

Voltage Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
V3	5.0	5.5
V4	5.5	6.0
V5	6.0	6.5
V6	6.5	7.0
V7	7.0	7.5

*Note 3: Individual flux bins are not orderable. Please refer to product ordering information on page 3 for a list of ordering part numbers.*

### Part Number Nomenclature

**XBT** — **3535** — **<UV>** — **<A###>** — **<FF###-##>**

Product Family	Package Type	Color	Package Configuration	Bin kit
XBT: UVC Surface Mount Package	3535: 3.5 mm x 3.5 mm	Ultraviolet	A130: 130 degree viewing angle	Flux and Wavelength bin kit code - See ordering informaton

### Ordering Part Numbers

The table below lists ordering part numbers available for XBT-3535-UV LEDs. The part number includes a bin kit, a group of flux and wavelength bins described in page 2, that are shippable for a given ordering part number . Individual flux or wavelength bins are not orderable . Flux bin listed is minimum bin shipped - higher bins may be included at Luminus' discretion.

Wavelength Range	Wavelength Bins	Radiometric Flux		Ordering Part Number
		Bin Kit Flux Code	Min. Flux (mW)	
270-280	270, 275	CC	30	XBT-3535-UV-A130-CC270-00
275-280	275	CC	30	XBT-3535-UV-A130-CC275-01
275-285	275, 280	CC	30	XBT-3535-UV-A130-CC275-00
270-280	270, 275	CD	35	XBT-3535-UV-A130-CD270-00
275-280	275	CD	35	XBT-3535-UV-A130-CD275-01
275-285	275, 280	CD	35	XBT-3535-UV-A130-CD275-00

**Optical and Electrical Characteristics<sup>1,3</sup>**

Parameter	Symbol	Value	Unit
Minimum Forward Voltage	$V_{f-min}$	5.0	V
Typical Forward Voltage	$V_{f-typ}$	6.5	V
Maximum Forward Voltage	$V_{f-max}$	7.5	V
FWHM	$\Delta\lambda$	10	nm
Viewing Angle	$2\theta_{1/2}$	130	°
Thermal Resistance (junction-solder point)	$R_{th}$	5.0	°C/W

**Absolute Maximum Ratings<sup>2,3</sup>**

Parameter	Symbol	Value	Unit
Forward Current	$I_{f-max}$	800	mA
Junction Temperature	$T_{j-max}$	100	°C

**Note 1:** Ratings are based on operation at a constant junction temperature of  $T_j = 25^\circ\text{C}$ . Test conditions: 350 mA, 20 ms pulse at  $25^\circ\text{C}$ .

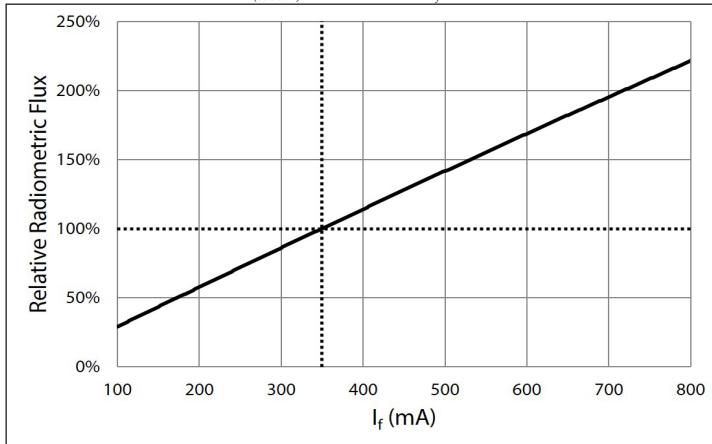
**Note 2:** Product lifetime is a function of drive current. Sustained operation at absolute maximum current of 800 mA will result in a reduction of device lifetime compared to typical forward drive currents (350-500 mA). Actual device lifetimes will also depend on junction temperature. Contact Luminus for details.

**Note 3:** XBT-3535-UV LEDs are short wavelength, deep UV LEDs. During operation, the LED emits high intensity UVC radiation, which is harmful to skin and eyes. UV light is also hazardous to skin and may cause cancer. Avoid exposure to deep UV light when LED is operational.

## Optical & Electrical Characteristics

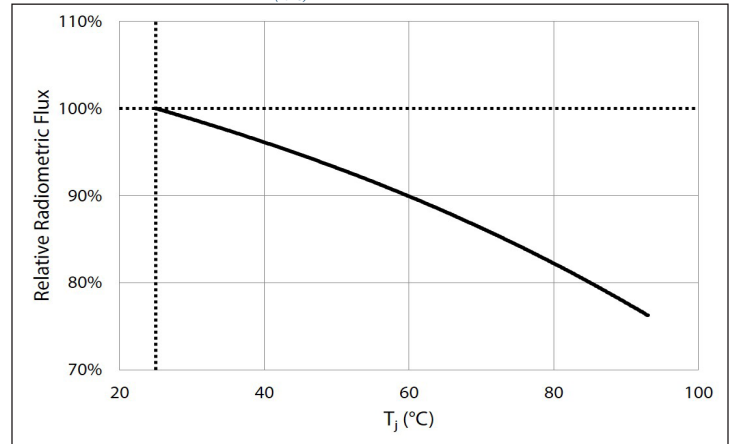
### Relative Power vs. Forward Current

$\phi/\phi_{(350\text{ mA})}$ , 20 ms pulse,  $T_j = 25^\circ\text{C}$



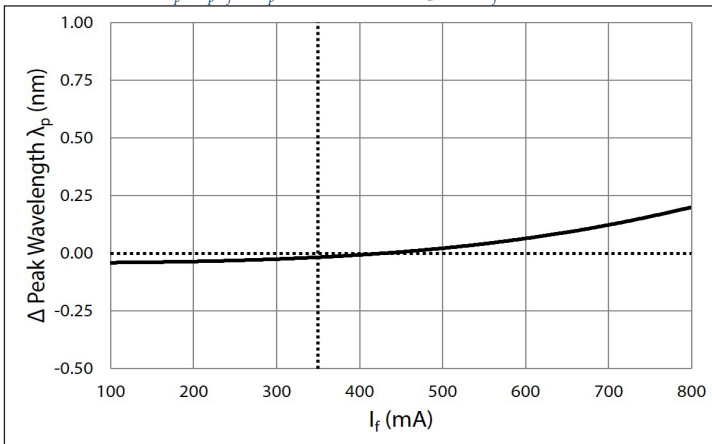
### Relative Power vs. Junction Temperature

$\phi/\phi_{(25^\circ\text{C})}$ , 20 ms pulse, 350 mA



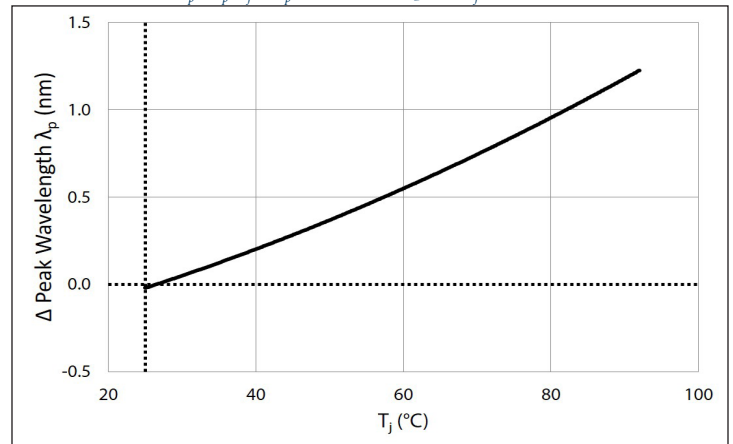
### Peak Wavelength Shift vs. Forward Current

$\lambda_p = \lambda_p(I_f) - \lambda_p(350\text{ mA})$ , 20 ms pulse,  $T_j = 25^\circ\text{C}$

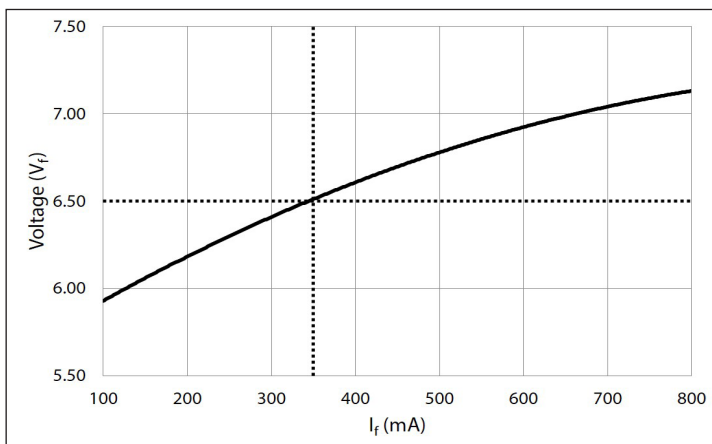


### Peak Wavelength Shift vs. Junction Temperature

$\lambda_p = \lambda_p(T_j) - \lambda_p(25^\circ\text{C})$ , 20 ms pulse,  $I_f = 350\text{ mA}$

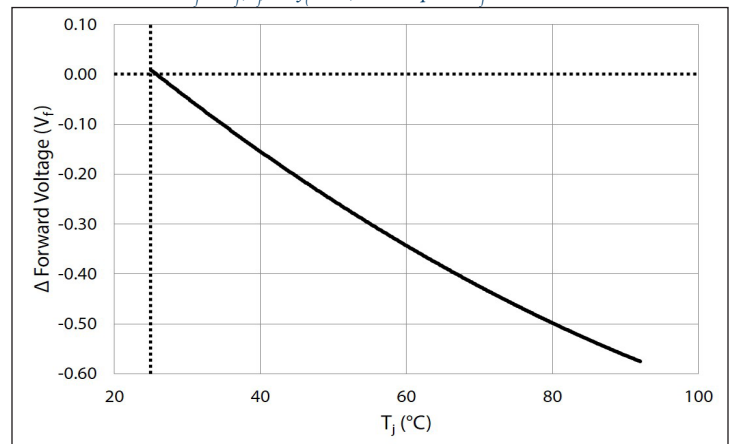


### Forward Voltage vs Forward Current

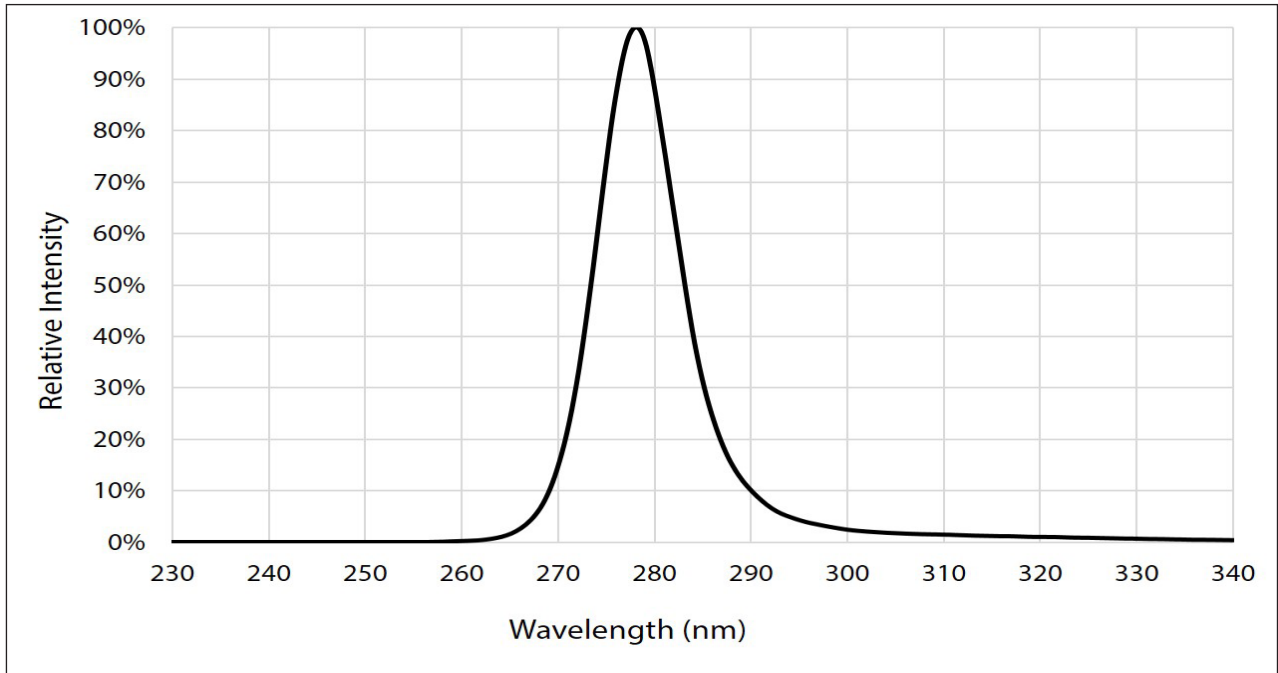


### Forward Voltage Shift vs. Junction Temperature

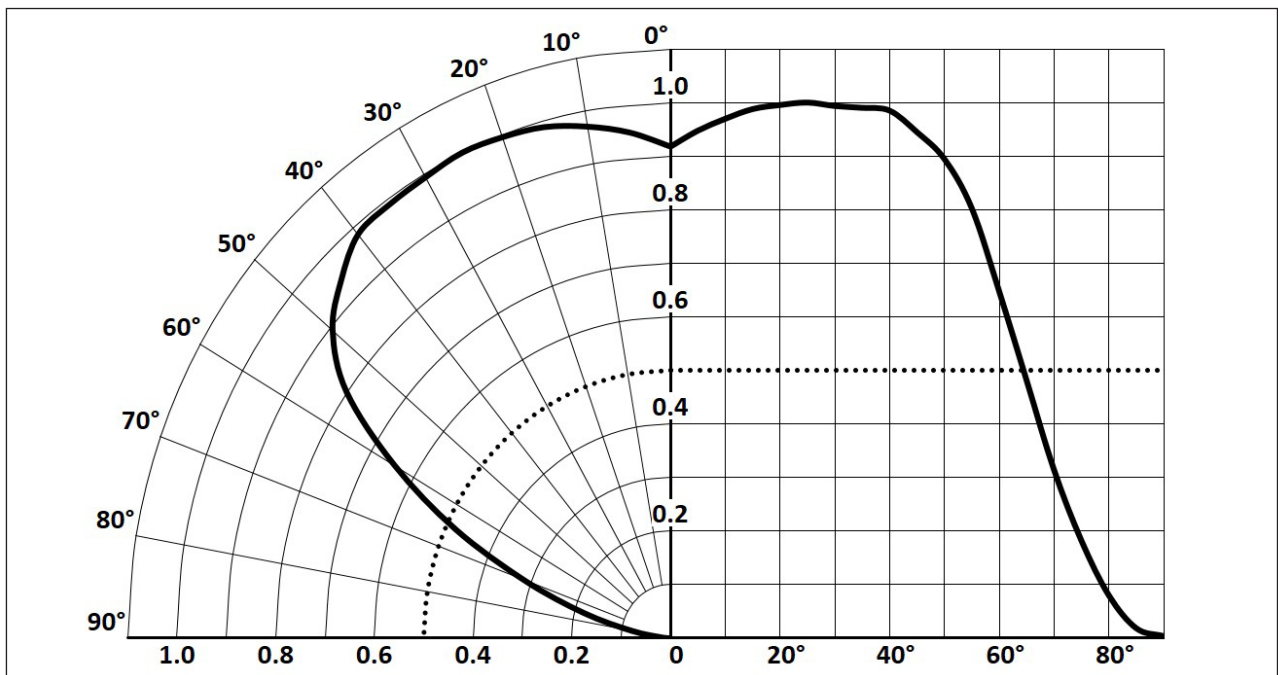
$\Delta V_f = V_f(T_j) - V_f(25^\circ\text{C})$ , 20 ms pulse,  $I_f = 350\text{ mA}$



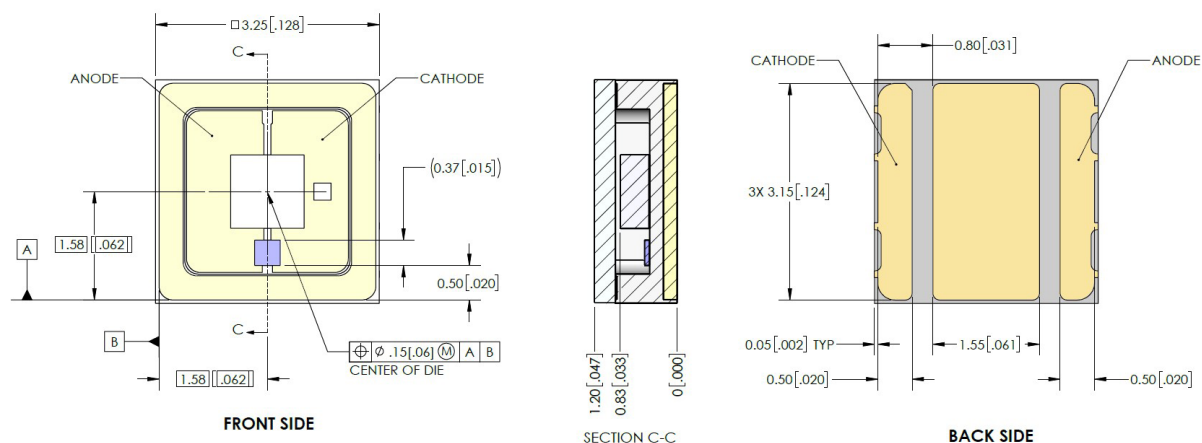
### Typical Spectrum



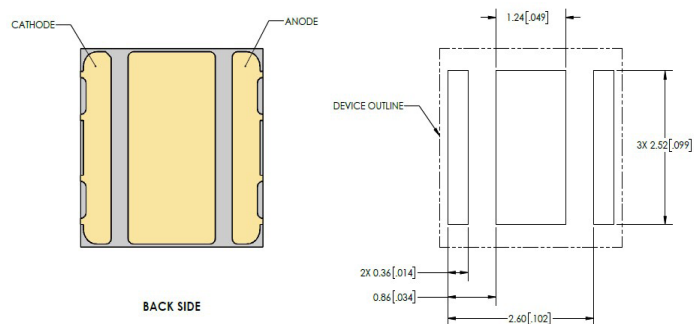
### Radiation Pattern



## Mechanical Dimensions

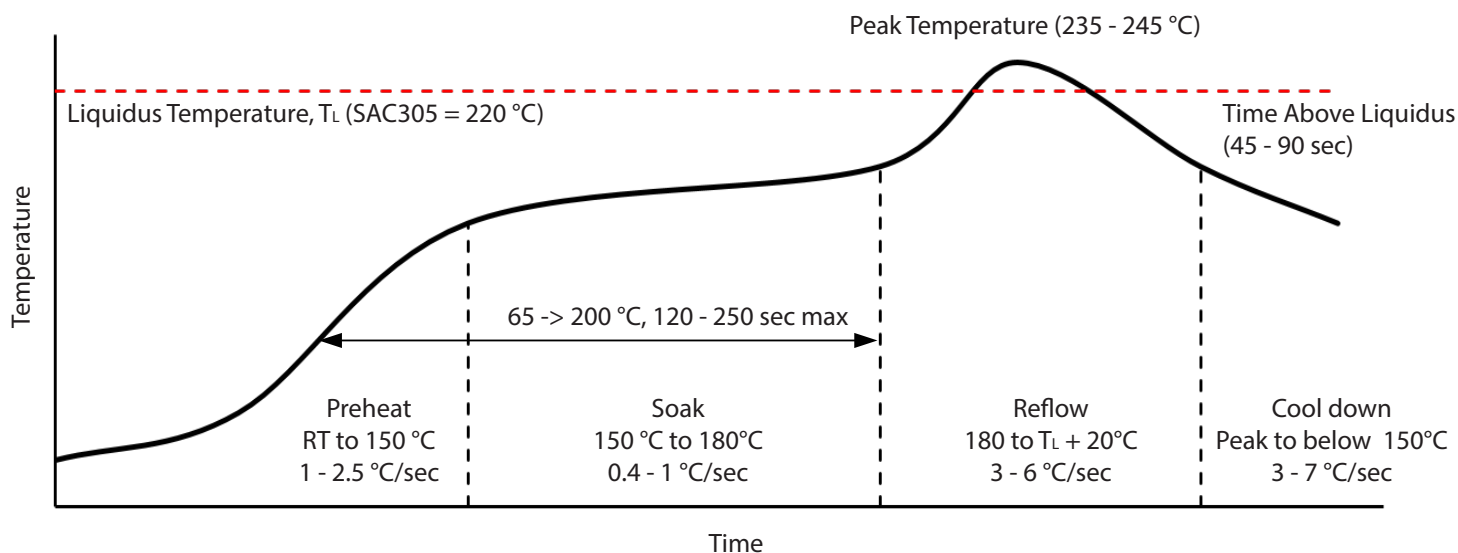


## Recommended Solder Pad and Stencil Pattern



Solder Pad	3.15 mm x 0.5 mm
Stencil Pattern	2.52 mm x 0.36 mm

## Solder Profile



SMT Rework Guideline	Manual Hotplate Reflow	Hot Air Gun Reflow
Heating Time	< 60 sec	
Hotplate Temperature	< 245 °C	< 150 °C

Note 1: Product complies to Moisture Sensitivity Level 1 (MSL 1)

Note 2: The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.

Note 3: During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N)

Note 4: Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.

Note 5: Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.

Note 6: Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.

Note 7: These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. For more information, please refer to: <https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components->

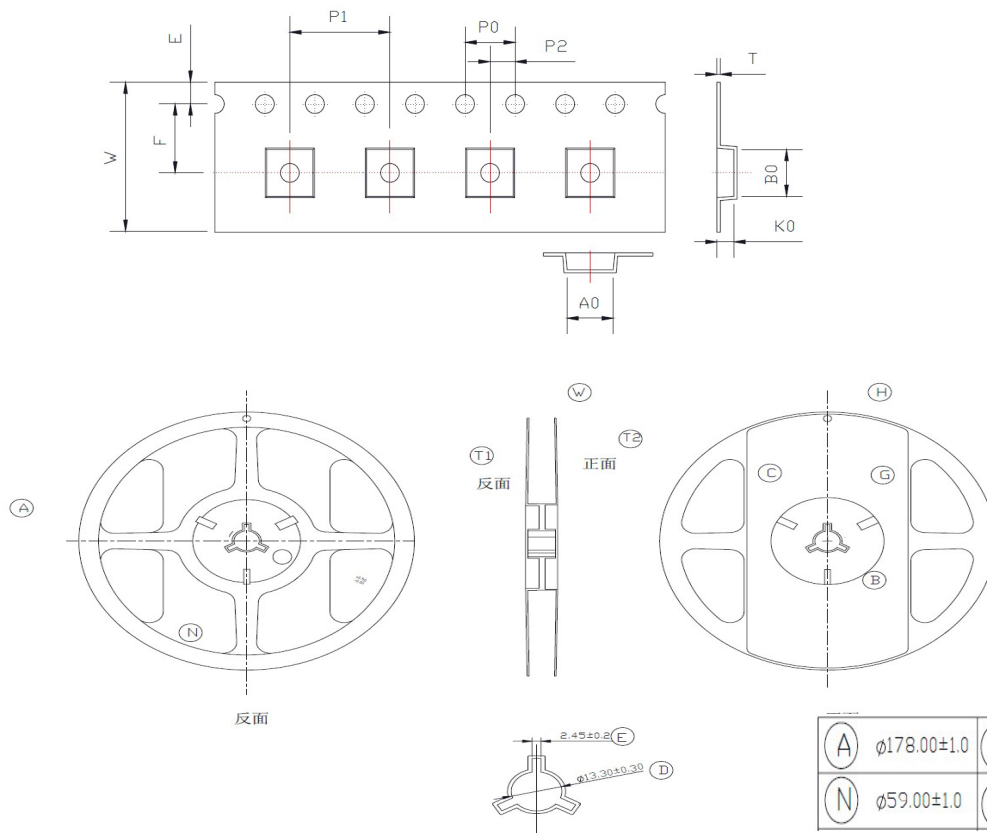
Note 8: For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.



## Product Shipping & Labeling Information

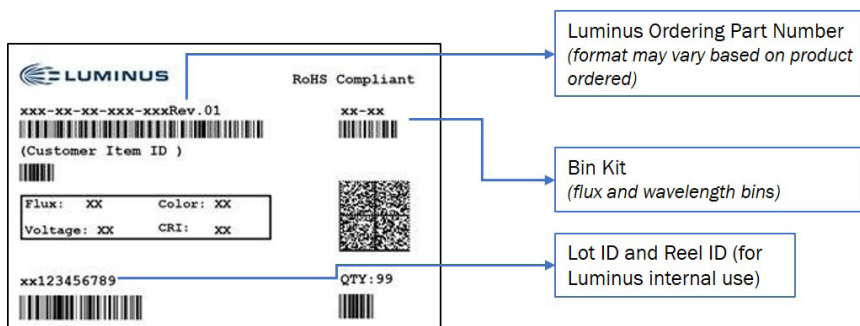
All XBT-3535 products are packaged and labeled with their respective bin as outlined in the tables on pages 2 & 3. Each reel will only contain one flux and one wavelength bin

symbol	AO	BO	KO	PO	P1	P2
Spec	3.80±0.10	3.80±0.10	1.35±0.10	4.00±0.10	8.0±0.10	2.0±0.10
symbol	W	T	E	F	DO	D1
Spec	12.0±0.3	0.25±0.05	1.75±0.10	5.50±0.05	1.50 <sup>+0.10</sup> <sub>-0</sub>	1.50±0.10



(A) $\phi 178.00 \pm 1.0$	(E) $2.45 \pm 0.2$	(G) $5.10 \pm 0.3$	(T1) $1.3 \pm 0.15$
(N) $\phi 59.00 \pm 1.0$	(B) $3.10 \pm 0.3$	(H) $\phi 4.30 \pm 0.3$	(T2) $1.10 \pm 0.15$

## XBT-3535-UV Label Information



Note: Bin Kit field on label may contain additional characters next to the wavelength bin: for e.g. 275A or 275B). These are for Luminus internal use only.

## Precautions for storage, handling and use of UV LEDs

### 1. UV Light

XBT-3535-UV LEDs are short wavelength, deep UV LEDs. During operation, the LED emits high intensity UVC radiation, which is harmful to skin and eyes. UV light is also hazardous to skin and may cause cancer. Avoid exposure to deep UV light when LED is operational.

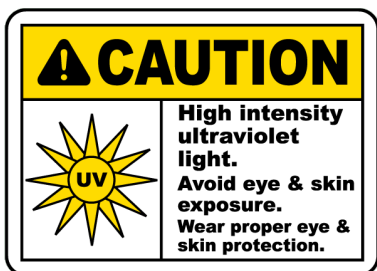
Precautions must be taken to avoid looking directly at the UV light without the use of UV light protective glasses. Do not look directly at the front or at the LED's lens when LED is operational.

### 2. Static Electricity (ESD)

While XBT 3535 LEDs have built-in Zener protection diodes, they are particularly sensitive to ESD (Electrostatic Discharge). Static electricity and surge voltages seriously damage UV LEDs and can result in complete failure of the device. Precautions must be taken against ESD when handling or operating these devices.

### 3. Operating Conditions

In order to ensure the correct functioning of these LEDs, compliance to maximum allowed specifications is important. UV LEDs are particularly sensitive to drive currents that exceed the max operating specifications and may be damaged by such drive currents. The use of current regulated drive circuits is strongly recommended when operating these devices. Customers should also provide adequate thermal management to ensure LEDs do not exceed maximum recommended temperatures. Operating LEDs at temperatures in excess of specification will result in damage and possibly complete failure of the device.



## History of Changes

Rev		Description of Change
1	04/01/2020	Initial Release
2	10/29/2020	New wavelength bins and Vf bins introduced
3	05/06/2024	Updated ordering part numbers